Docket No.: OGOSH59USA

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.

10/598,471

Confirmation No. 5838

Applicant

Yuichiro Shindo et al.

371 Filed

August 31, 2006

Art Unit

1793

Examiner

Vanessa T. Velasquez

Customer No.

00270

Title

HIGH-PURITY RU POWDER, SPUTTERING TARGET

OBTAINED BY SINTERING THE SAME, THIN FILM

OBTAINED BY SPUTTERING THE TARGET AND PROCESS

FOR PRODUCING HIGH-PURITY RU POWDER

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

RESPONSE TO RESTRICTION REQUIREMENT

Sir:

This is a timely response to the written Restriction Requirement dated September 8, 2008.

Election

In the present application, Applicants elect without traverse to prosecute the invention directed to a ruthenium powder, sputtering target and thin film. Thus, <u>Group I</u> is elected and includes claims 1 and 8-22.

Please charge any deficiency or credit any overpayment for entering this Response to our deposit account no. 08-3040.

Respectfully submitted, HOWSON & HOWSON LLP Attorneys for Applicant

By ___/William Bak/ William Bak Reg. No. 37,277 501 Office Center Drive Suite 210 Fort Washington, PA 19034 (215) 540-9216